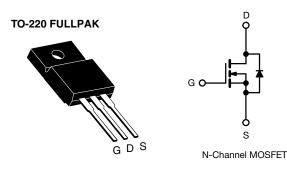
## SiHF065N60E

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Vishay Siliconix

### **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.057		
Q <sub>g</sub> max. (nC)	74			
Q <sub>gs</sub> (nC)	19			
Q <sub>gd</sub> (nC)	15			
Configuration	Single			

#### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
    - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION			
Package	TO-220 FULLPAK		
Lead (Pb)-free and halogen-free	SiHF065N60E-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	V	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C) $^{\circ}$	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1	40	А	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	25		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	116		
Linear derating factor				2.0	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	226	mJ	
Maximum power dissipation			PD	39	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		alı . (alt	70	N//mm	
Reverse diode dv/dt <sup>d</sup>			dv/dt	50	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			260	°C	
Mounting torque	M3 screw			0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.0 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt = 400$  A/µs, starting  $T_J = 25 \ ^\circ C$ 

e. Limited by maximum junction temperature

S18-0933-Rev. A, 17-Sep-2018



COMPLIANT HALOGEN



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	65	°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	3.2	C/W		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•	•	•	•
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.72	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3	-	5	V
Gate-source leakage	I <sub>GSS</sub>	1	$V_{GS} = \pm 20 V$		-	± 100	nA
		l l	$V_{\rm GS} = \pm 30  \rm V$	-	-	± 1	μA
Zene entre uniterne durin summert		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	10	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 16 A	-	0.057	0.065	Ω
Forward transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 16 A		-	12	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2700	-	pF
Output capacitance	C <sub>oss</sub>			-	102	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V		-	93	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	593	-	
Total gate charge	Qg			-	49	74	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 16 \text{ A}, \text{ V}_{DS} = 480 \text{ V}$		19	-	nC
Gate-drain charge	Q <sub>gd</sub>				15	-	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}$ = 480 V, I <sub>D</sub> = 16 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 9.1 Ω		-	28	56	- ns
Rise time	t <sub>r</sub>			-	46	92	
Turn-off delay time	t <sub>d(off)</sub>			-	54	108	
Fall time	t <sub>f</sub>			-	13	26	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	
Pulsed diode forward current	I <sub>SM</sub>			-	-	116	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 16 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 16 \text{ A},$ di/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 400 V		-	382	764	ns
Reverse recovery charge	Q <sub>rr</sub>			-	7.1	14.2	μC
Reverse recovery current	I <sub>RRM</sub>			-	34	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

2



# SiHF065N60E

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

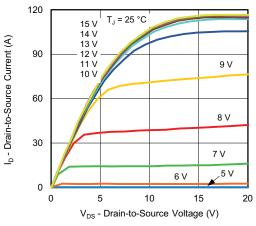


Fig. 1 - Typical Output Characteristics

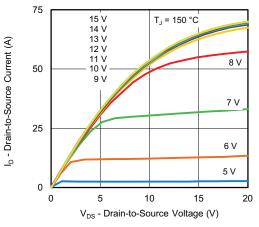


Fig. 2 - Typical Output Characteristics

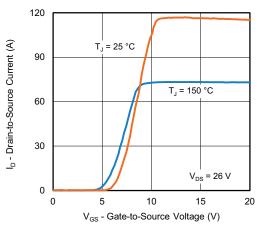


Fig. 3 - Typical Transfer Characteristics

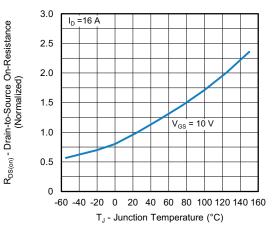


Fig. 4 - Normalized On-Resistance vs. Temperature

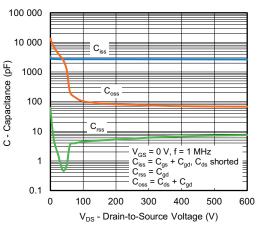


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

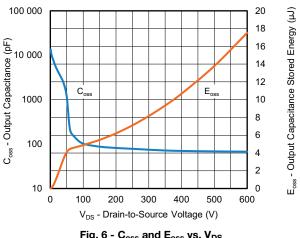


Fig. 6 - Coss and Eoss vs. VDS

S18-0933-Rev. A, 17-Sep-2018

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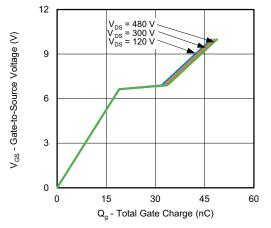


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

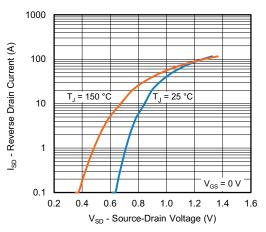


Fig. 8 - Typical Source-Drain Diode Forward Voltage

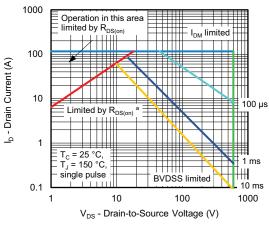


Fig. 9 - Maximum Safe Operating Area

Note

a. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

4

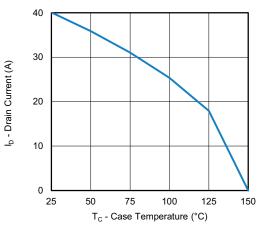


Fig. 10 - Maximum Drain Current vs. Case Temperature

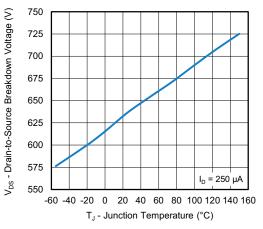
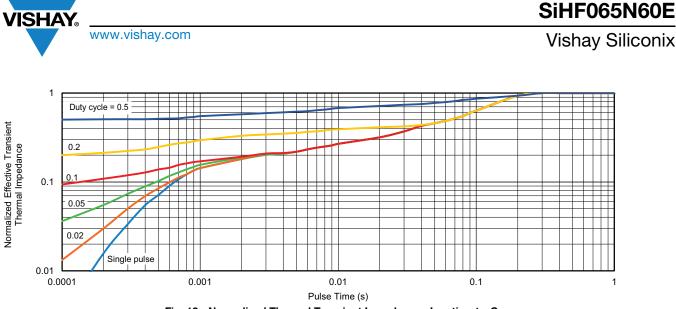


Fig. 11 - Temperature vs. Drain-to-Source Voltage





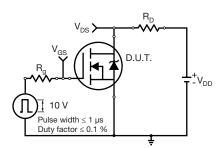


Fig. 13 - Switching Time Test Circuit

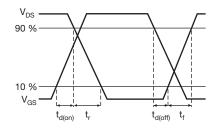


Fig. 14 - Switching Time Waveforms

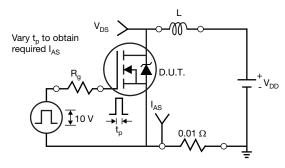


Fig. 15 - Unclamped Inductive Test Circuit

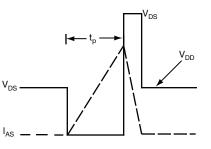


Fig. 16 - Unclamped Inductive Waveforms

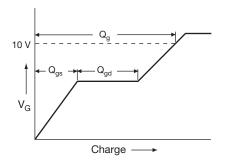


Fig. 17 - Basic Gate Charge Waveform

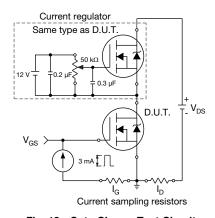
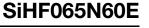


Fig. 18 - Gate Charge Test Circuit

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5



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#### Peak Diode Recovery dv/dt Test Circuit

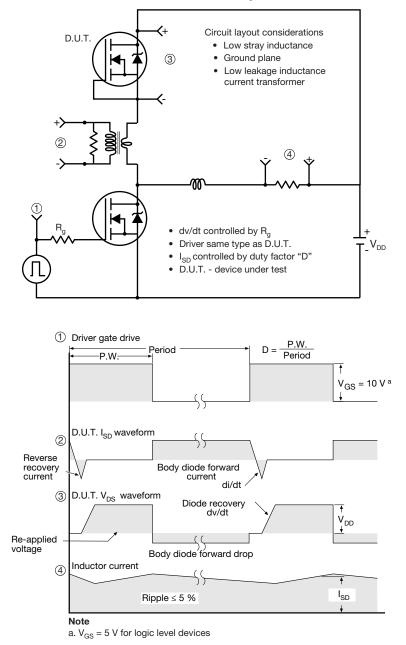


Fig. 19 - For N-Channel

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